

HIGH-SPEED CMOS OCTAL INVERTING BUFFER TRANSCEIVER

IDT54/74AHCT640

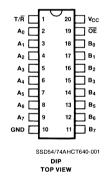
FEATURES:

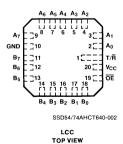
- Equivalent to ALS speeds and output drive over full temperature and voltage supply extremes
- 10ns data to output
- I_{OL} = 14mA over full military temperature range
- CMOS power levels (5µW typ. static)
- Both CMOS and TTL output compatible
- Substantially lower input current levels than ALS (5μA max.)
- · Inverting buffer transceiver
- 100% product assurance screening to MIL-STD-883, Class B is available
- JEDEC standard pinout for DIP and LCC

DESCRIPTION:

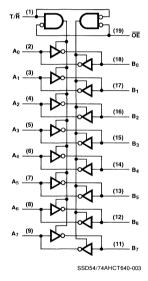
The IDT54/74AHCT640 are 8-bit inverting buffer transceivers built using advanced CEMOSTM, a dual metal CMOS technology. These octal bus transceivers are designed for asynchronous two-way communication between data buses. The devices transmit data from the A bus to the B bus or from the B bus to the A bus depending upon the level at the direction control ($\overline{T/R}$) input. The enable input (\overline{OE}) can be used to disable the device so the buses are effectively isolated.

PIN CONFIGURATIONS





FUNCTIONAL BLOCK DIAGRAM



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ABSOLUTE MAXIMUM RATING(1)

| SYMBOL | RATING | COMMERCIAL | MILITARY | UNIT |
|-------------------|--|--------------|--------------|------|
| V _{TERM} | Terminal Voltage with Respect to GND | -0.5 to +7.0 | -0.5 to +7.0 | ٧ |
| T _A | Operating Temperature | 0 to +70 | -55 to +125 | °C |
| T _{BIAS} | Temperature Under Bias | -55 to +125 | -65 to +135 | °C |
| T _{STG} | Storage Temperature | -55 to +125 | -65 to +155 | °C |
| I _{OUT} | DC Output Current | 120 | 120 | mA |

NOTE:

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

 $T_A = 0^{\circ}C$ to $+70^{\circ}C$ $V_{CC} = 5.0V \pm 5\%$

 $T_A = -55^{\circ}C \text{ to } +125^{\circ}C$ $V_{CC} = 5.0V \pm 10\%$ Min. = 4.75V Min. = 4.50V Max. = 5.25V (Commercial)

Max. = 5.50V (Military)

 $\dot{V_{LC}} = 0.2V$

 $V_{HC} = V_{CC} - 0.2V$

| SYMBOL | PARAMETER | TEST CO | MIN. | TYP.(2) | MAX. | UNIT | |
|-----------------|-----------------------|--|---|-----------------|-----------------|-----------------|----|
| V _{IH} | Input HIGH Level | Guaranteed Logic | 2.0 | _ | _ | ٧ | |
| V _{IL} | Input LOW Level | Guaranteed Logic | Low Level | _ | _ | 0.8 | ٧ |
| I _{IH} | Input HIGH Current | V _{CC} = Max., V _{IN} = V | V _{CC} = Max., V _{IN} = V _{CC} | | | 5 | μΑ |
| IIL | Input LOW Current | V _{CC} = Max., V _{IN} = C | _ | _ | -5 | μА | |
| Isc | Short Circuit Current | V _{CC} = Max. (3) | -60 | -100 | _ | mA | |
| | Output HIGH Voltage | $V_{CC} = 3V$, $V_{IN} = V_{LC}$ or V_{HC} , $I_{OH} = -32\mu A$ | | | V _{CC} | | |
| V | | V _{CC} = Min. V _{IN} = V _{IH} or V _{IL} | I _{OH} = -150μA | V _{HC} | V _{CC} | _ | V |
| V _{OH} | | | I _{OH} = -12mA MIL | 2.4 | 4.3 | _ | |
| | | | I _{OH} = -15mA COM | 2.4 | 4.3 | _ | |
| | | $V_{CC} = 3V$, $V_{IN} = V_{LC}$ or V_{HC} , $I_{OL} = 300 \mu A$ | | _ | GND | V _{LC} | |
| | Output LOW Voltage | | I _{OL} = 300μA | _ | GND | V _{LC} | v |
| V OL | Output LOW Voltage | V _{CC} = Min. V _{IN} = V _{IH} or V _{II} | I _{OL} = 14mA MIL | _ | T - | 0.4 | " |
| | | AIN - AIH OL AIF | I _{OL} = 24mA COM | | _ | 0.5 |] |

- 1. For conditions shown as max. or min., use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at $V_{\rm CC}$ = 5.0V, +25°C ambient and maximum loading.
- 3. Not more than one output should be shorted at one time. Duration of the short circuit test should not exceed one second.

^{1.} Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

POWER SUPPLY CHARACTERISTICS

 $V_{LC} = 0.2V$; $V_{HC} = V_{CC} - 0.2V$

| SYMBOL | PARAMETER | TEST CON | TEST CONDITIONS ⁽¹⁾ | | | MAX. | UNIT |
|--------|--|---|---|-----|-------|------|------------|
| Icca | Quiescent Power Supply Current | $V_{CC} = Max.$ $V_{IN} \ge V_{HC}; V_{IN} \le V_{LC}$ $f_i = 0$ | $V_{IN} \ge V_{HC}$; $V_{IN} \le V_{LC}$ | | 0.001 | 1.5 | mA |
| Гсст | Power Supply Current Per TTL Input HIGH | V _{CC} = Max. V _{IN} = 3.4V ⁽³⁾ | V _{CC} = Max. V _{IN} = 3.4V ⁽³⁾ | | 0.5 | 1.6 | mA |
| Iccd | Dynamic Power Supply Current | V _{CC} = Max. Outputs Open OE = GND T/R = GND or V _{CC} One Input Toggling 50% Duty Cycle | $V_{IN} \ge V_{HC}$ $V_{IN} \le V_{LC}$ | | 0.15 | 0.25 | mA/ MHz |
| | Total Power Supply Current ⁽⁴⁾ | V _{CC} = Max. Outputs Open f _i = 1.0MHz | $V_{IN} \ge V_{HC}$ $V_{IN} \le V_{LC}$ (AHCT) | _ | 0.15 | 1.8 | |
| Icc | | 50% Duty Cycle OE = GND One Bit Toggling | V _{IN} = 3.4V or V _{IN} = GND | _ c | 0.4 | 2.6 | mA |
| | | V _{CC} = Max. Outputs Open f _i = 250kHz | $V_{IN} \ge V_{HC}$ $V_{IN} \le V_{LC}$ (AHCT) | _ | 0.3 | 2.0 | |
| | | 50% Duty Cycle OE = GND Eight Bits Toggling | V _{IN} = 3.4V or V _{IN} = GND | | 2.3 | 8.4 | |

NOTES:

- 1. For conditions shown as max. or min., use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at V_{CC} = 5.0V, +25°C ambient and maximum loading.
- 3. Per TTL driven input (V $_{\rm IN}$ = 3.4V); all other inputs at V $_{\rm CC}$ or GND.
- 4. ICC = IQUIESCENT + INPUTS + IDYNAMIC
 - $I_{CC} = I_{CCQ} + I_{CCT}D_HN_T + I_{CCD} (f_{CP}/2 + f_iN_i)$
 - I_{CCQ} = Quiescent Current
 - I_{CCT} = Power Supply Current for a TTL High Input (V_{IN} = 3.4V)
 - D_H = Duty Cycle for TTL Inputs High
 - N_T = Number of TTL Inputs at D_H
 - I_{CCD} = Dynamic Current caused by an Input Transition pair (HLH or LHL)
 - f_{CP} = Clock Frequency for Register Devices (Zero for Non-Register Devices)
 - f; = Input Frequency
 - N_i = Number of Inputs at f_i
 - All currents are in milliamps and all frequencies are in megahertz.

DEFINITION OF FUNCTIONAL TERMS

| PIN NAMES | DESCRIPTION | |
|--------------------------------|----------------------------------|--|
| ŌĒ | Output Enable Input (Active LOW) | |
| T/R | Transmit/Receive Input | |
| A ₀ -A ₇ | Side A Inputs or | |
| | 3-State Outputs | |
| B ₀ -B ₇ | Side B Inputs or | |
| | 3-State Outputs | |

FUNCTION TABLE

| INP | UTS | |
|-----|-----|---------------------|
| ŌĒ | T/Ŕ | OPERATION |
| L | L | Bus B Data to Bus A |
| L | Н | Bus A Data to Bus B |
| Н | Х | Isolation |

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

| SYMBOL | | | TVD1041 | COMMERCIAL | | MILITARY | | UNITS |
|--------------------------------------|--|---------------------------------------|----------------|------------|------|----------|------|-------|
| | PARAMETER | CONDITION | TYPICAL | MIN. | MAX. | MIN. | MAX. | UNITS |
| t _{PLH} t _{PHL} | Propagation Delay A to B or B to A | | 10.0 | 2.0 | 11.0 | 2.0 | 14.0 | ns |
| t _{ZH} t _{ZL} | Output Enable Time | C_L = 50 pf R_L = 500 Ω | 15.0 | 5.0 | 24.0 | 5.0 | 27.0 | ns |
| t _{HZ} t _{LZ} | Output Disable Time | | 12.0 | 2.0 | 15.0 | 2.0 | 20.0 | ns |